

N-Channel 100V MOSFET

E100N4P5AH1

V_{DS} (V)	$R_{DS(on),max}$ (m Ω)	I_D (A)
100V	4.5 @ $V_{GS} = 10V$	130

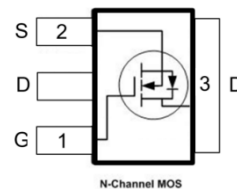
Features

- Low $R_{DS(on)}$ trench technology
- Low thermal impedance
- Fast switching speed
- 100% avalanche tested

Applications

- DC/DC conversion
- Power switch
- PD charger
- Moto driver

TO-220



Package And Ordering Information

Ordering code	Package	Marking
E100N4P5AH1	TO-220	E100N4P5AH1

Ordering Information

Package	Units/ Tube	Tubes/ Inner Box	Units/ Inner Box
TO-220	50	20	1000

Key Performance Parameters

Parameter	Value	Unit
VDS, min @ Tj(max)	100	V
ID, pulse	675	A
RDS(ON), max @ VGS=10V	4.5	mΩ
Qg	91	nC

Absolute Maximum Ratings at Tj=25°C Unless Otherwise Noted

Parameter		Symbol	Limit	Unit
Drain-source voltage		V _{DS}	100	V
Gate-source voltage		V _{GS}	±20	
Continuous drain current	T _C =25°C	I _D	130	A
	T _C =100°C		110	
Pulsed drain current		I _{D,pulse}	675	
Avalanche energy, single pulse		E _{AS}	484	mJ
Power dissipation	T _C =25°C	P _D	250	W
	T _A =25°C		-	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to 175	°C

Thermal Characteristics

Parameter		Symbol	Max.	Unit
Thermal resistance, junction-to-case	Steady state	R _{θJC}	0.6	°C/W
Thermal resistance, junction-to-ambient	Steady state	R _{θJA}	60	

Electrical Characteristics at Tj=25°C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Static						
Drain to source breakdown voltage	V _{(BR)DSS}	100			V	V _{GS} = 0, I _D = 250 μA
Gate-source threshold voltage	V _{GS(th)}	2.2	2.8	3.2	V	V _{DS} = V _{GS} , I _D = 250 μA
Gate-body leakage	I _{GSS}			±100	nA	V _{DS} = 0 V, V _{GS} = ±20 V
Zero gate voltage drain current	I _{DSS}			1	μA	V _{DS} = 100 V, V _{GS} = 0 V
Drain-source on-resistance	R _{DS(on)}		3.5	4.5	mΩ	V _{GS} = 10 V, I _D = 40 A
Forward transconductance	g _{fs}		-		S	V _{DS} = 5 V, I _D = 30 A

Gate resistance	R _g		1.8		Ω	f=1MHz
Gate Charge						
Total gate charge	Q _g		91		nC	V _{DS} = 50 V, I _D = 40 A, V _{GS} = 10 V
Gate-source charge	Q _{gs}		25			
Gate-drain charge	Q _{gd}		25			
Dynamic						
Turn-on delay time	t _{d(on)}		21		ns	V _{DS} = 50 V, I _D =40 A, V _{GS} = 10 V, R _{GEN} = 3 Ω
Rise time	t _r		69			
Turn-off delay time	t _{d(off)}		57			
Fall time	t _f		70			
Input capacitance	C _{iss}		5440		pF	V _{DS} =50 V, V _{GS} = 0 V, f = 1MHz
Output capacitance	C _{oss}		1035			
Reverse transfer capacitance	C _{rss}		35			
Body Diode						
Diode forward voltage	V _{SD}		0.8	1.2	V	V _{GS} = 0 V, I _F = 40 A
Reverse recovery time	t _{rr}		59		ns	V _{GS} = 0 V, I _S =40 A, di/dt = 100
Reverse recovery charge	Q _{rr}		71		nC	A/μs

Electrical Characteristics Diagrams

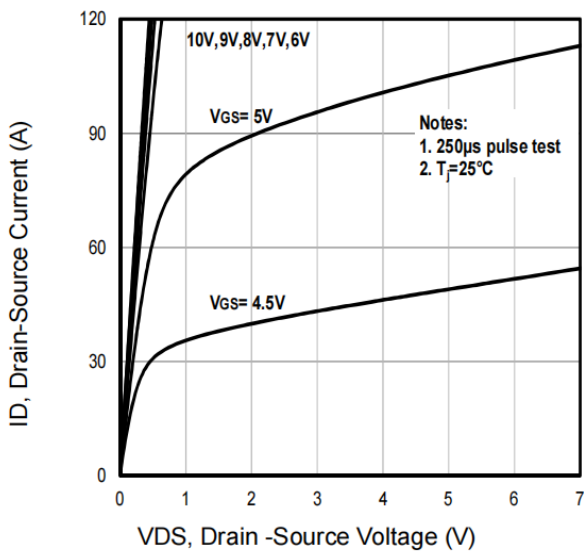


Fig1. Typical Output Characteristics

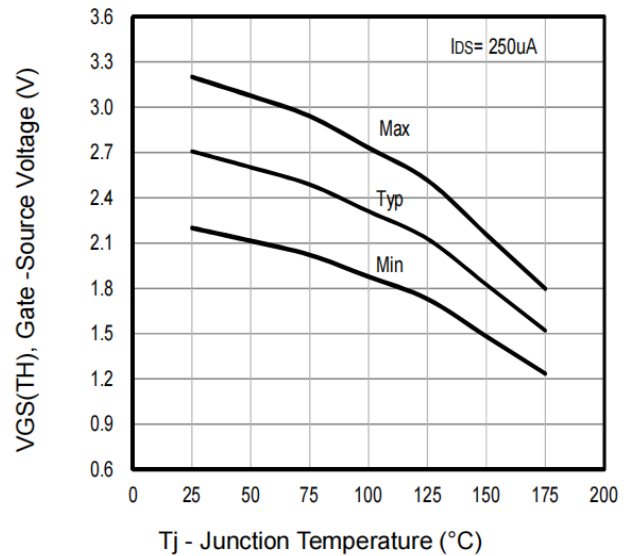
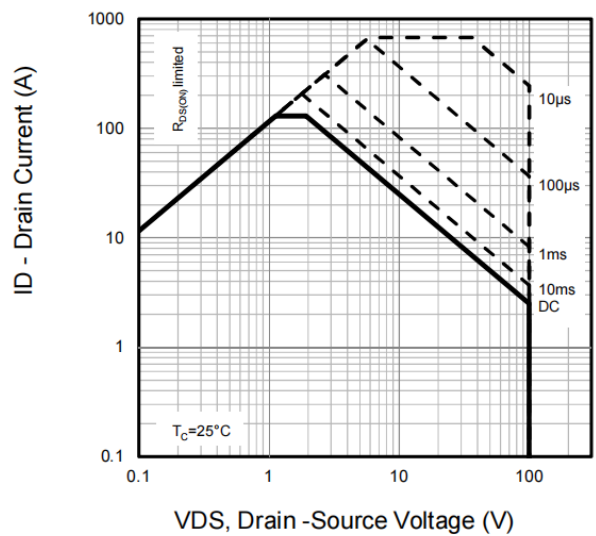
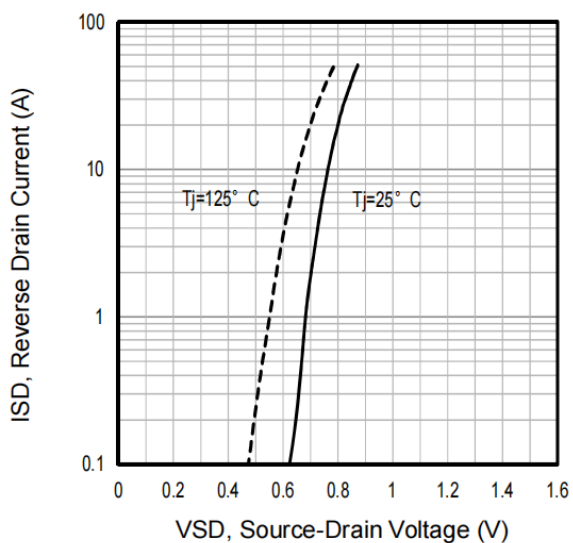
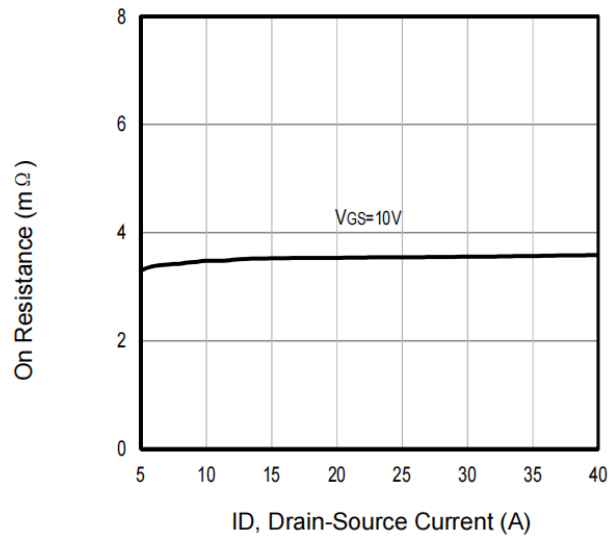
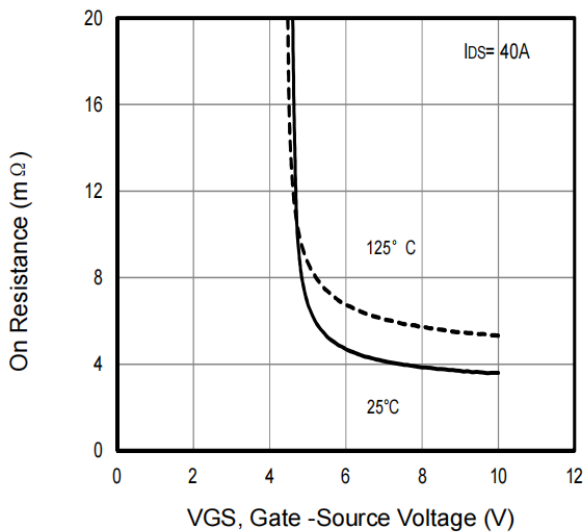
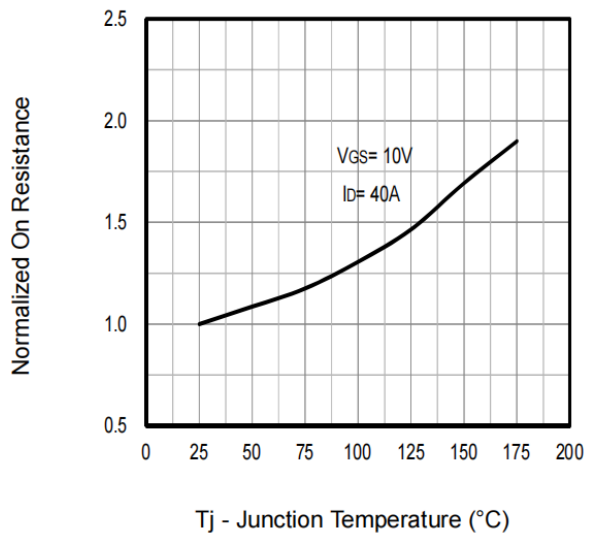
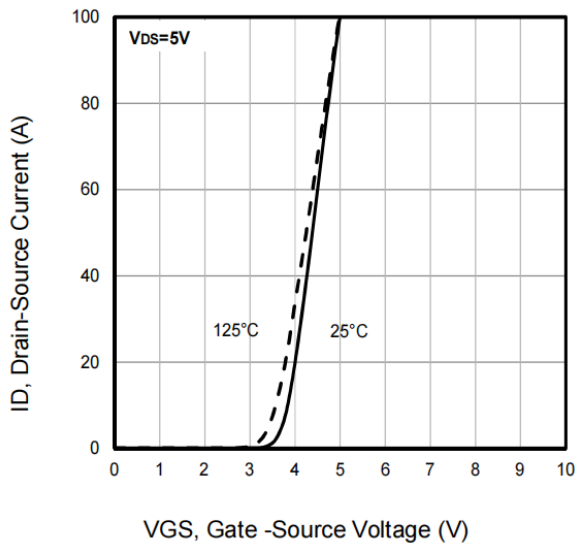


Fig2. $V_{GS(TH)}$ Gate-Source Voltage Vs. T_j



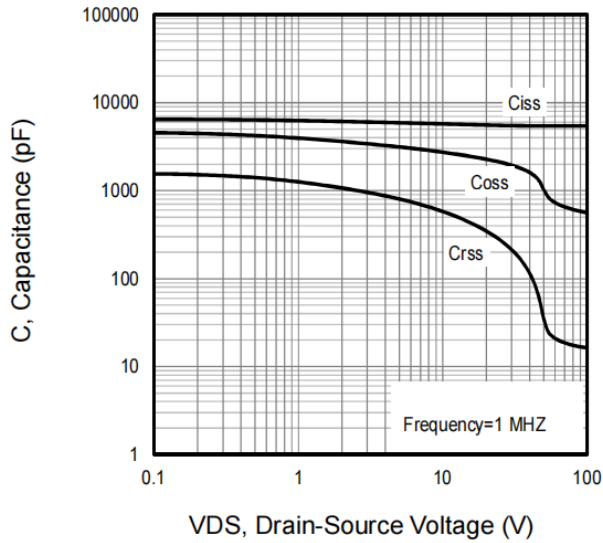


Fig9. Typical Capacitance Vs. Drain-Source Voltage

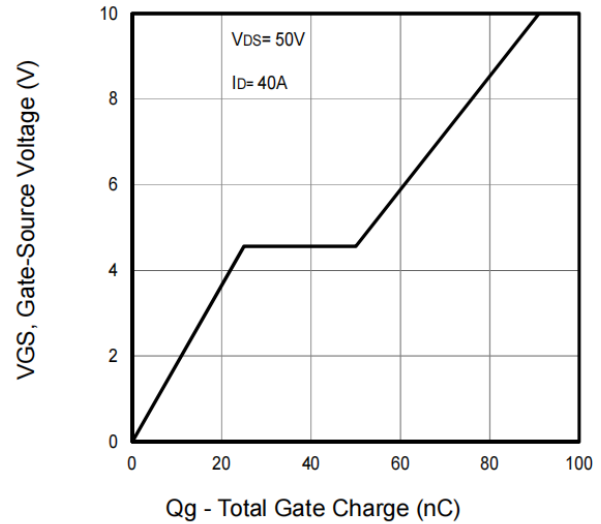


Fig10. Typical Gate Charge Vs. Gate-Source Voltage

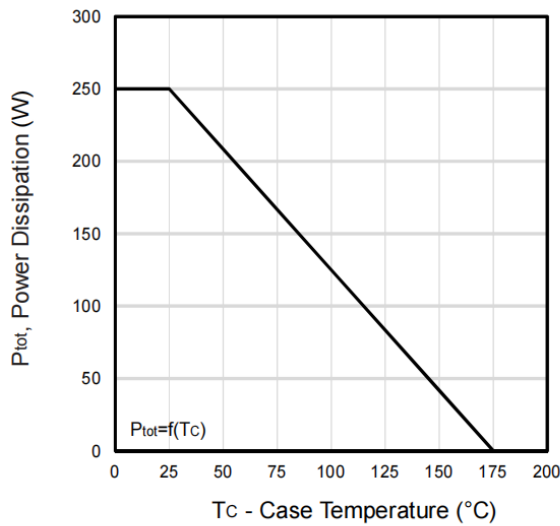


Fig11. Power Dissipation Vs. Case Temperature

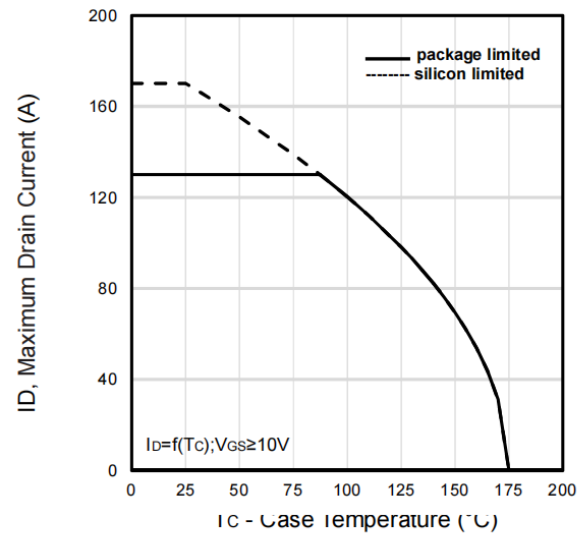


Fig12. Maximum Drain Current Vs. Case Temperature

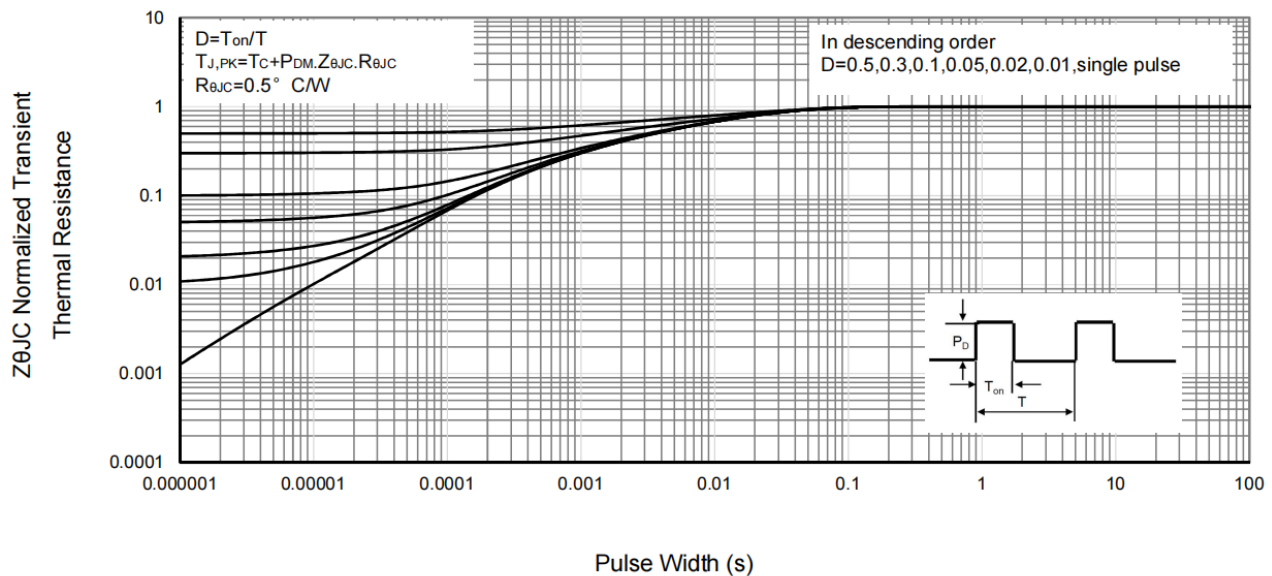


Fig13 . Normalized Maximum Transient Thermal Impedance

Test circuits and waveforms

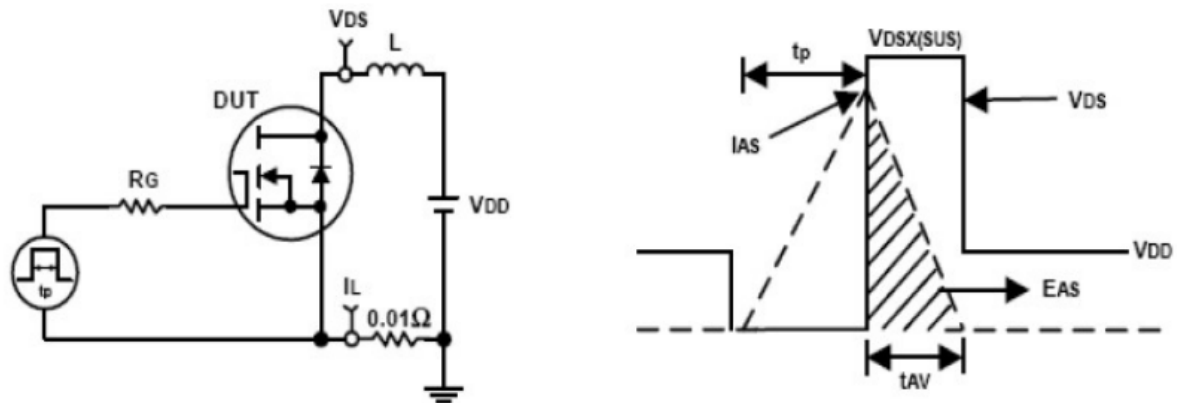


Fig14. Unclamped Inductive Test Circuit and waveforms

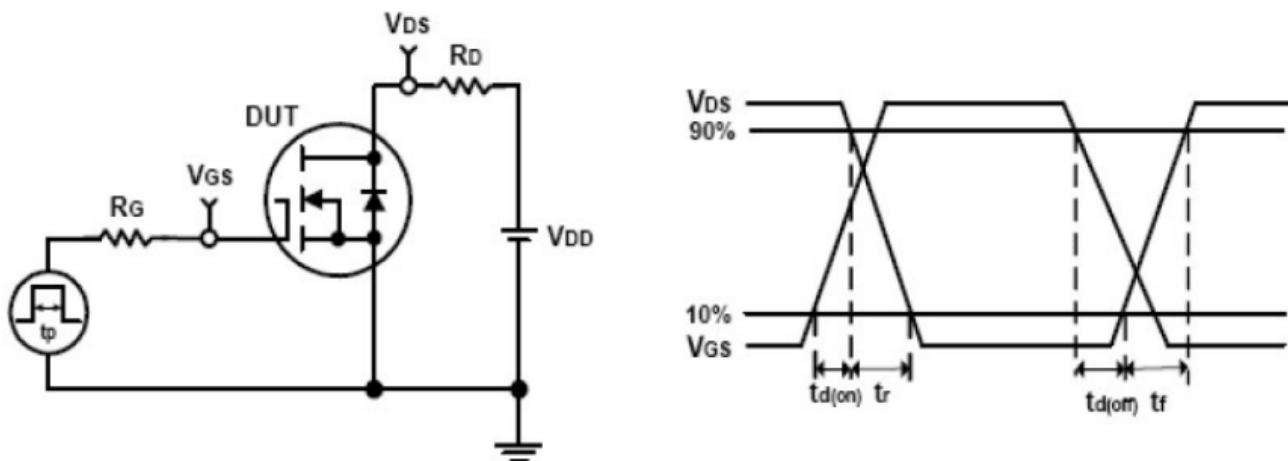
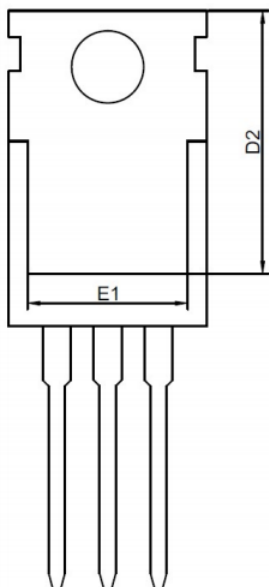
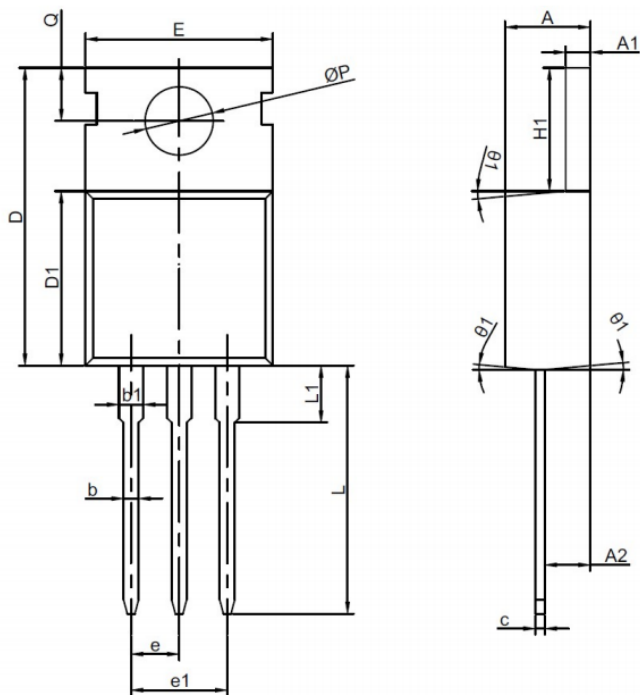


Fig15. Switching Time Test Circuit and waveforms

Package Outline Dimensions



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
A	4.30	4.52	4.70
A1	1.15	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	1.00
b1	1.15	1.32	1.50
c	0.45	0.50	0.65
D	15.10	15.70	16.10
D1	8.80	9.20	9.40
D2	12.80	-	13.70
E	9.65	9.90	10.30
E1	7.00	-	8.2
e	2.54 BSC		
e1	5.08 BSC		
H1	6.20	6.50	6.90
L	12.70	-	13.90
L1	-	-	3.50
ØP	3.40	3.60	3.80
Q	2.60	2.80	3.00
Ø1	1 °	3 °	7 °

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